



SUNNYWAY



SWD015

PN:SZ19275IA93

Features:

- Frequency bands: 1575MHz
- Patch antenna
- High gain, Small size
- Impedance 50 Ohm

Applications:

- Solution for all global public constellations:
GPS/GALILEO

Sunnyway Technology

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1. Electrical Specification

Standards	GPS/GALILEO
Frequency range(MHz)	1575MHz
Peak Gain (dBi)	3.0
Average Gain (dB)	-3.6
VSWR	1.1
Return Loss (dB)	-23.3
Efficiency (%)	44.0
Polarization mode	Linear
Radiation pattern	Omni-Directional
Output impedance (Ω)	50

Note: All parameters are measured with Sunnyway's EVK which size is 90*50mm

2. Mechanical and Environmental Specification

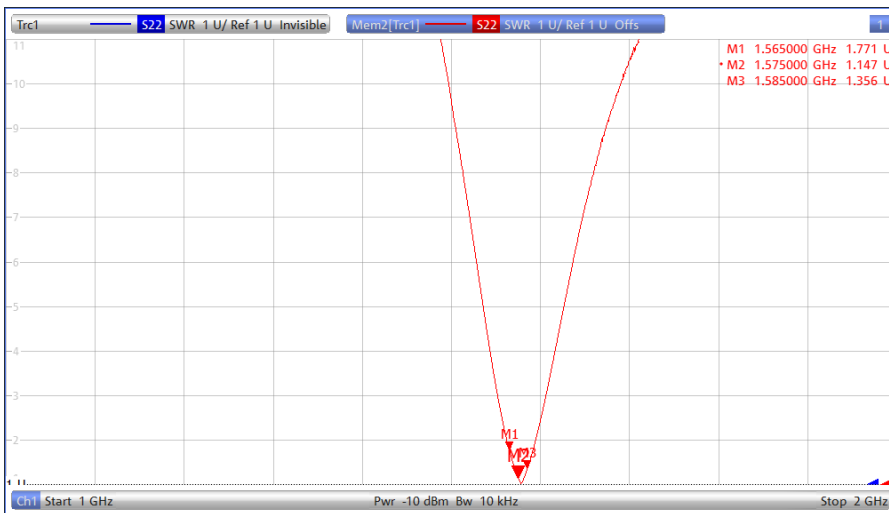
Mounting Type	SMD
Adhesive Type	/
Connector Type	/
Antenna size(mm)	3.20*1.60*0.60
Material	Ceramic
Operating Temperature (°C)	- 40 °C ~ + 85 °C
Storage Temperature(°C)	- 40 °C ~ + 85 °C

3. Antenna parameters

3.1 General Specification

FRE (MHz)	1565	1575	1585
VSWR	1.7	1.1	1.3
Return Loss (dB)	-11.1	-23.3	-16.4
Eff (%)	40.5	44.0	43.8
Average Gain(dB)	-4.0	-3.6	-3.6

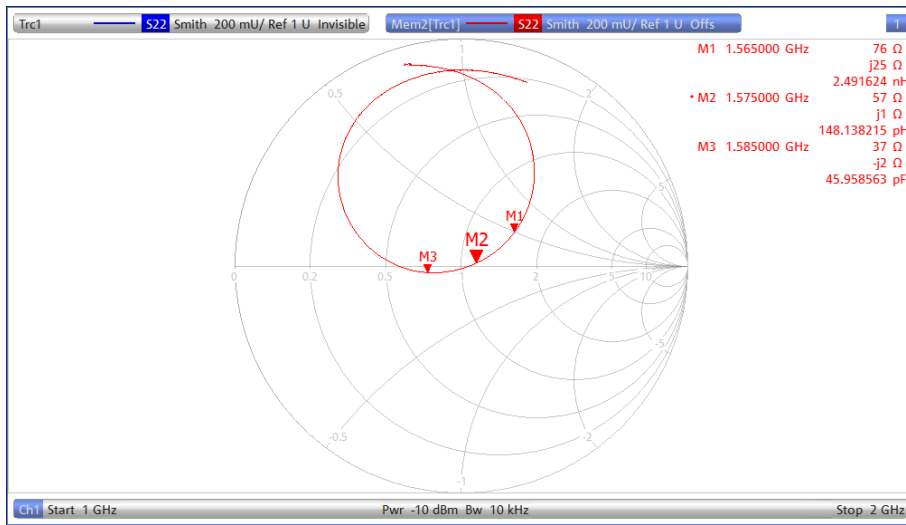
3.2 VSWR



3.3 Return Loss

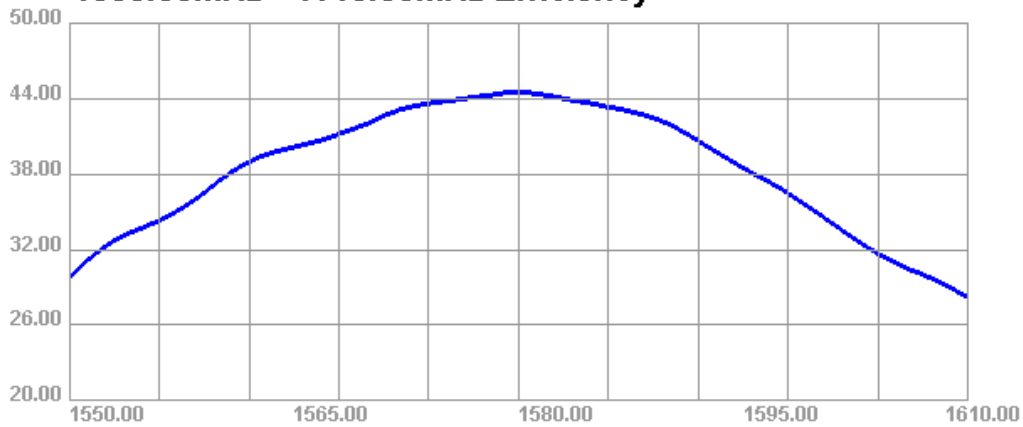


3.4 Smith



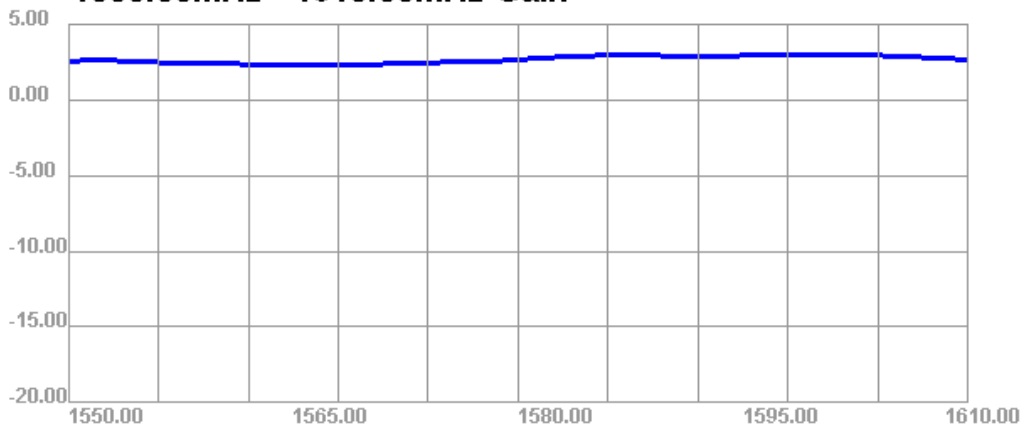
3.5 Efficiency

1550.00MHz - 1610.00MHz Efficiency






3.6 Gain

1550.00MHz - 1610.00MHz Gain

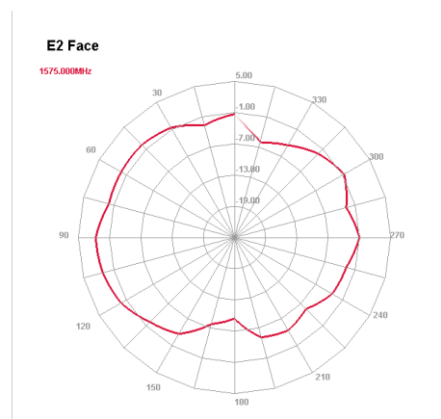
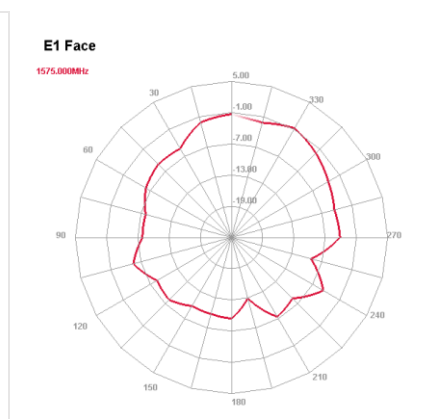
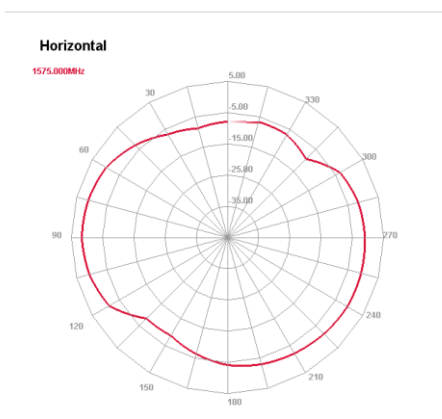
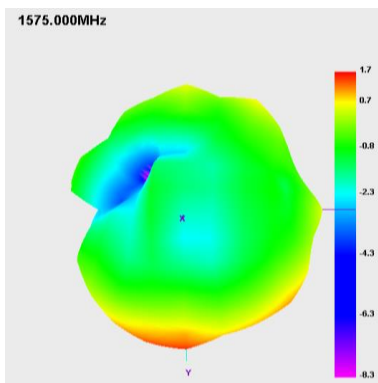


3.7 Directional pattern

H plane: the tangent of XY^{\perp}
 E1 plane: the tangent of XZ^{\perp}
 E2 plane: the tangent of YZ^{\perp}

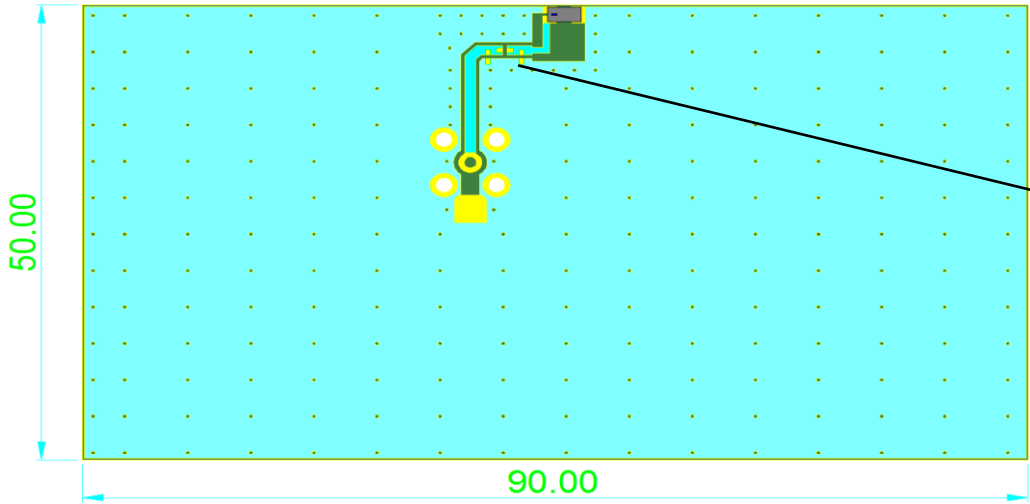




Theta = 0
Phi = 0

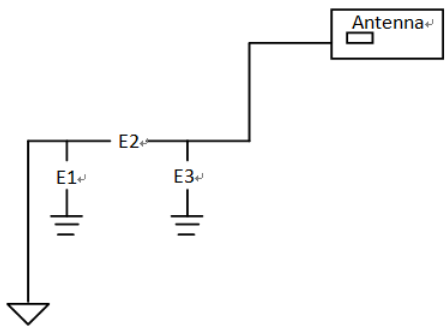




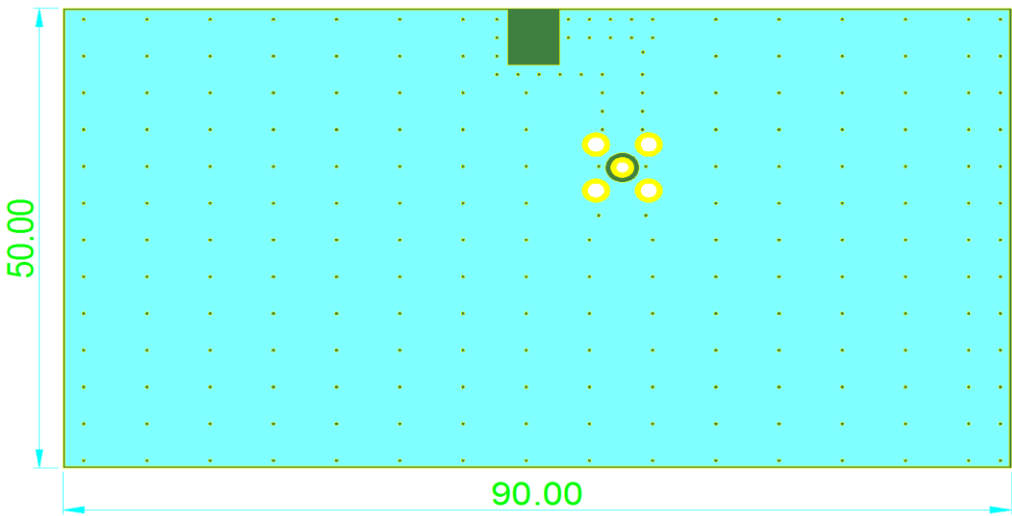
4. Evaluation Board and Matching Circuits



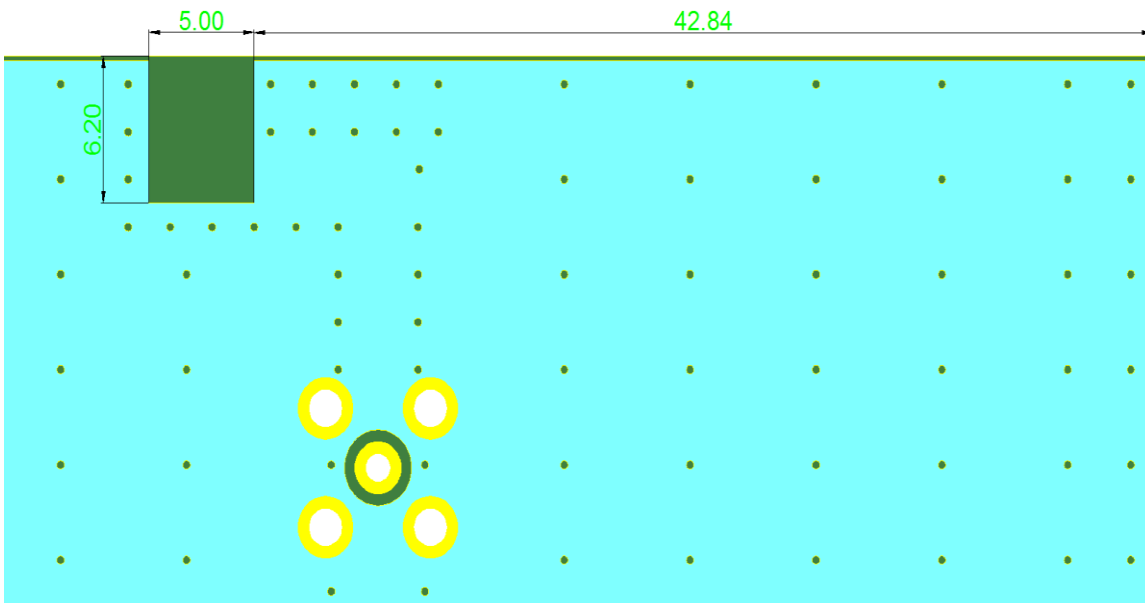
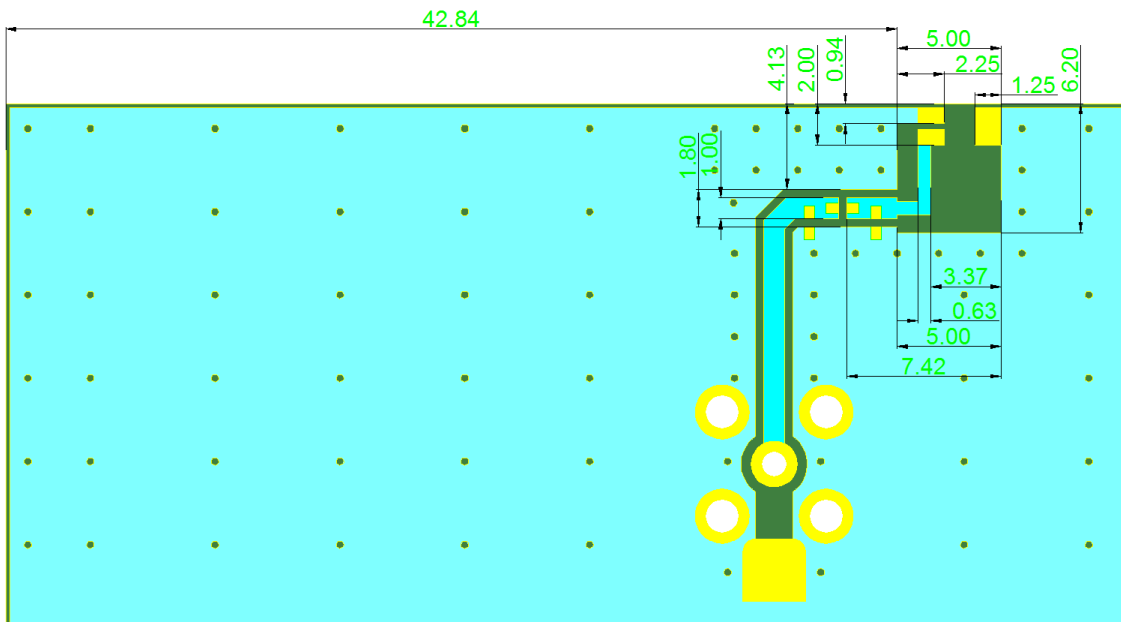
π Type Matching Network



	Type	Value
E1	Capacitor	1.5PF
E2	Inductor	15NH
E3	Inducto	10NH



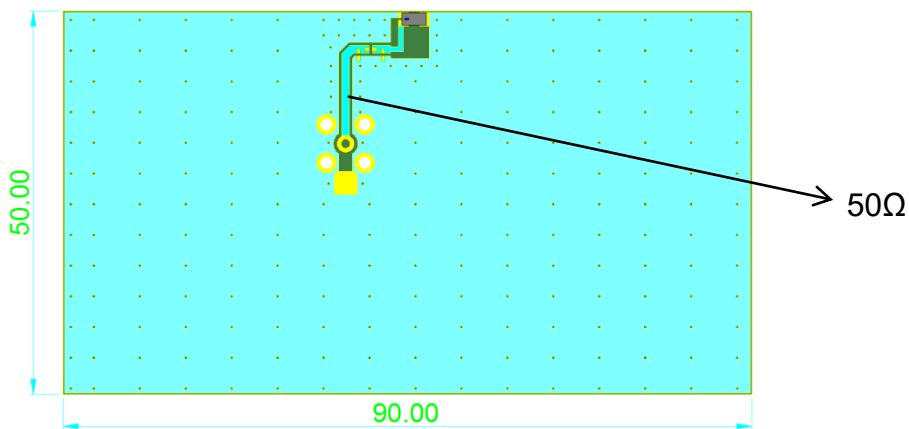
Unit: : mm



5. Transmission Line

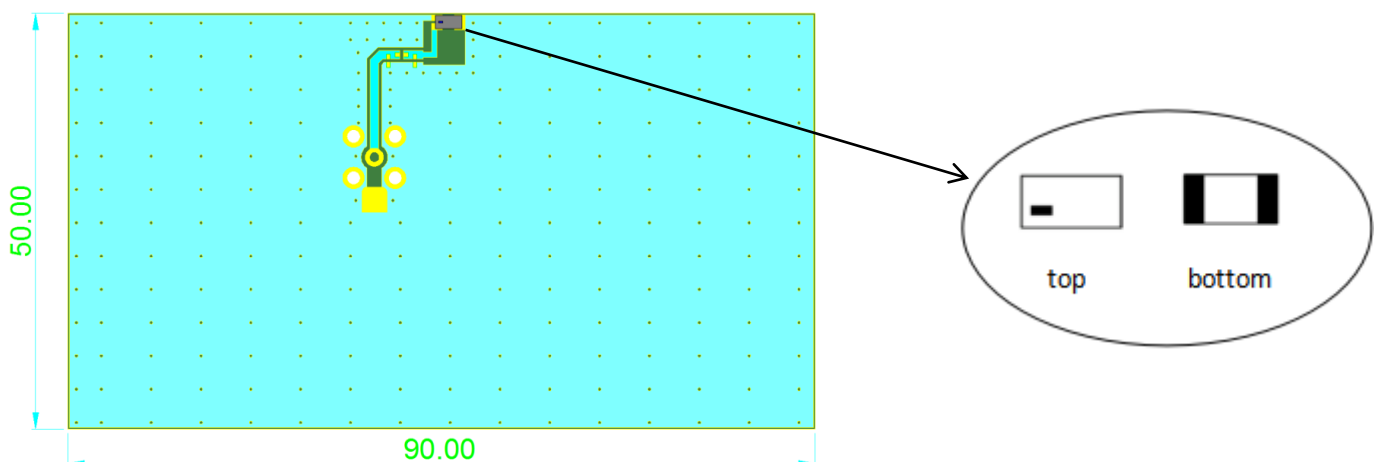
The characteristic impedance of all transmission lines shall be designed as 50 Ω .

- The length of the transmission lines should be kept to as short as possible
- Any other part of the RF system, such as transceiver, power amplifiers, etc., shall also be designed with an impedance of 50 Ω



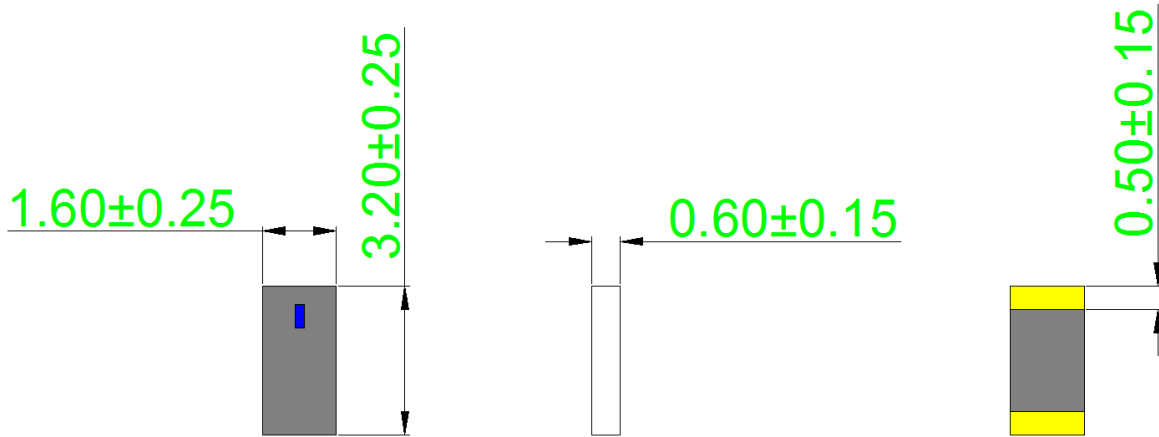
6. Antenna installation

The printed circuit board of the host must ensure that the antenna clearance area meets the antenna specifications. It is recommended to place the antenna at the center of the long side of the PCB.





7. Antenna Drawing



8. Post Dependability Tolerance

Post Dependability Tolerance (Refer to the table)

No	item	Post Dependability Tolerance
8.1	Central Frequency	$\pm 5\text{MHz}$
8.2	Band Width	$\pm 5\text{MHz}$
8.3	Gain	$\pm 0.1 \text{ dBi}$
8.4	V.S.W.R (in BW)	± 0.1

9. Reliability Test

Temperature range	25±5°C
Relative Humidity range	55~75%RH
Operating Temperature range	-40°C~+85°C
Storage Temperature range	-40°C~+85°C

9.1 Vibration Resist

The device should satisfy the electrical characteristics specified in paragraph 8.1~8.4 after applied to the vibration of 10 to 55Hz with amplitude of 1.5mm for 2 hours each in X, Y and Z directions.

9.2 Drop Shock

The device should satisfy the electrical characteristics specified in paragraph 8.1~8.4 after dropping onto the hard wooden board from the height of 100cm for 3 times each facet of the 3 dimensions of the device.

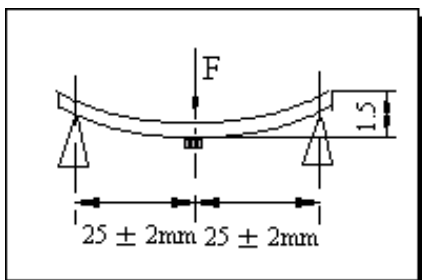
9.3 Solder Heat Proof

The device should be satisfied after preheating at 120°C~150°C for 120 seconds and dipping in soldering Sn at 255°C+10°C for 5±0.5 seconds, or electric iron 300°C-10°C for 3±0.5 seconds, without damage.

9.4 Tensile Strength of Terminal

The device should not be broken after tensile force of 1.0kg is slowly applied to pull a lead pin of the fixed device in the lead axis direction for 10±1 seconds.

9.5 Bending Resist Test



Weld the product to the center part of the PCB with the thickness 1.6±0.2mm as the illustration shows, and keep exerting force arrow-ward on it at speed of 1mm/S, and hold for 5±1S at the position of 1.5mm bending distance, so far, any peeling off of the product metal coating should not be detected.

9.6 Moisture Proof

The device should satisfy the electrical characteristics specified in paragraph 8.1~8.4 after exposed to the temperature $60\pm 2^{\circ}\text{C}$ and the relative humidity 90~95% RH for 96 hours and 1~2 hours recovery time under normal condition.

9.7 High Temperature Endurance

The device should satisfy the electrical characteristics specified in paragraph 8.1~8.4 after exposed to temperature $85\pm 5^{\circ}\text{C}$ for 96 ± 2 hours and 1~2 hours recovery time under normal temperature.

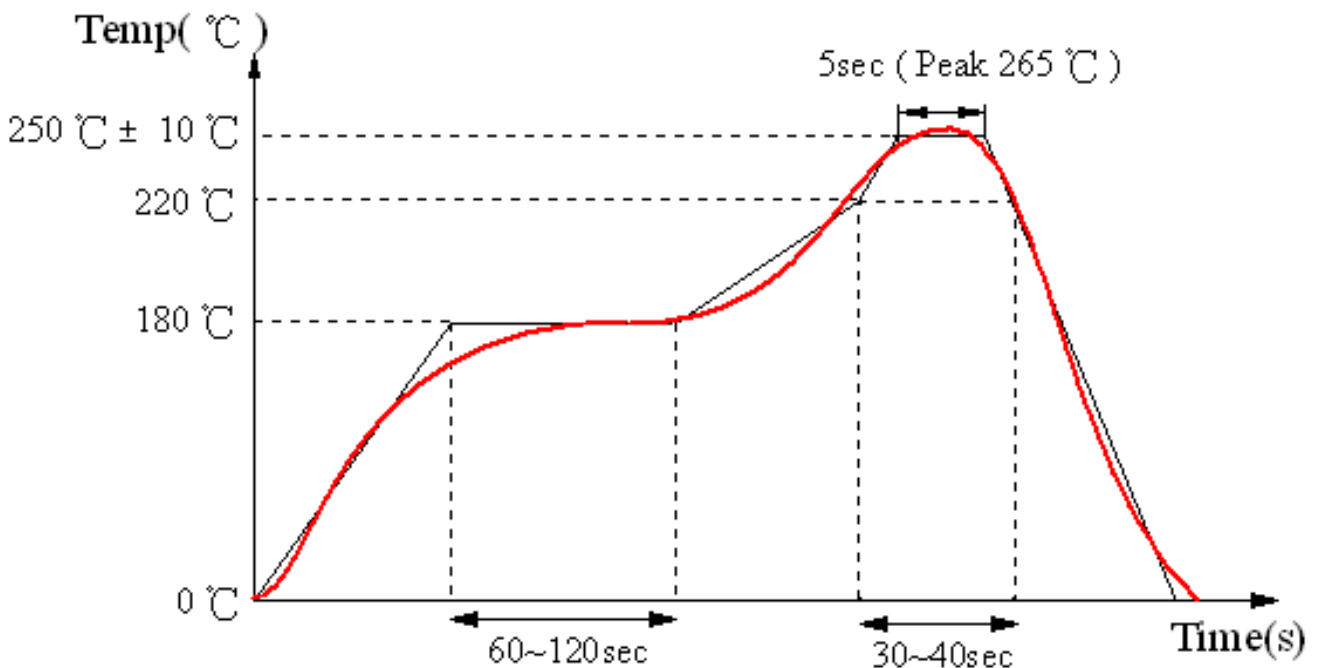
9.8 Low Temperature Endurance

The device should also satisfy the electrical characteristics specified in paragraph 8.1~8.4 after exposed to the temperature $-40^{\circ}\text{C}\pm 5^{\circ}\text{C}$ for 96 ± 2 hours and to 2 hours recovery time under normal temperature.

9.9 Temperature Cycle Test

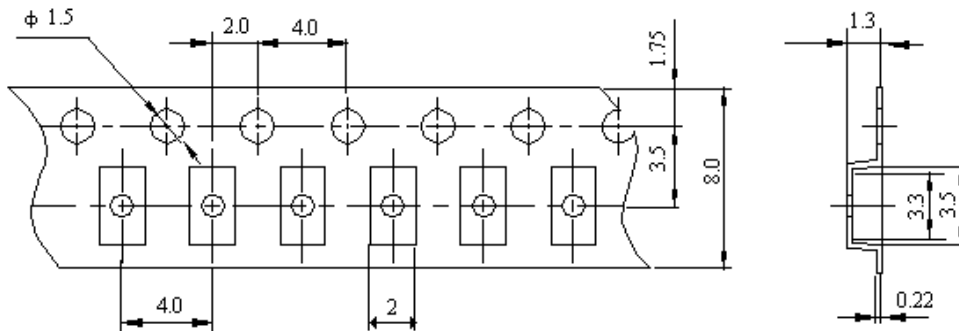
The device should also satisfy the electrical characteristics specified in paragraph 8.1~8.4 after exposed to the low temperature -40°C and high temperature $+85^{\circ}\text{C}$ for 30 ± 2 min each by 5 cycles and 1 to 2 hours recovery time under normal temperature.

10. Reflow Soldering Standard Condition



11. Packaging and Dimension

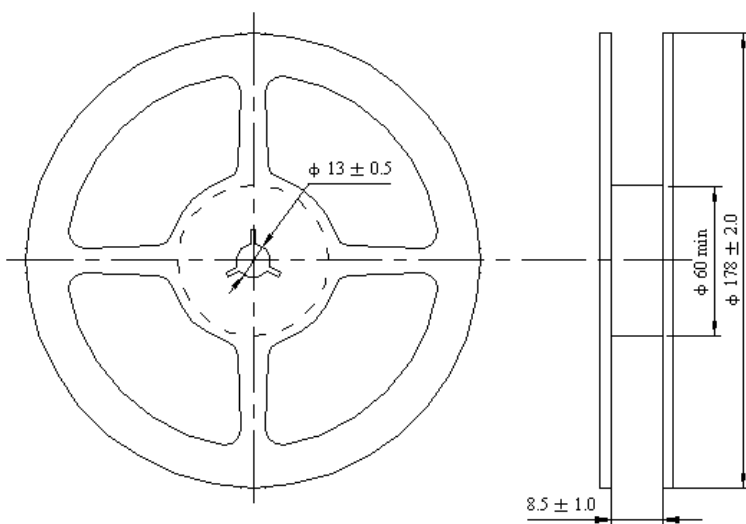
11.1 Plastic Tape



Remarks for Package

Reserve a length of 150~200mm for the trailer of the carrier and 250~300 mm for the leader of the carrier and further 250mm of cover tape at the leading part of the carrier.

11.2 Reel (3000 pcs/Reel)



11.3 Storage Period

Oxidizable, 12 months in vacuum sealed bag . Material, please repack within 168 hours by re-seal the package treatment after use them!

Storage Temperature Range : <30 degree C, Humidity : <60%RH